

R6 Release Notes of IEC Type 5: Composable Integrated Edge Cloud (IEC) Server Blueprint Family

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Summary

This document provides the release note forComposable Integrated Edge Cloud (IEC) Server Blueprint Family.

what is released

In R6, we introduce an innovative networking architecture based on PCIe data fabric to lower both the cost (CAPEX) and power consumption (OPEX) in small clusters for edge cloud computing. Based-on innovative data processor (DPU and XPU), the next-generation networking features with:

- New networking architecture to lower the TCO of edge infrastructure
- TCP/IP compatible and cloud native for develops and developers
- Green to protect the environment for lasting development
- Scalable and composable to meet the dynamical workload

| | |
|---------------------------|---------------|
| — IEC Type 5 | Latest update |
| — System Architecture | R6 |
| — Software & Platform API | - |
| — Hardware Design | R6 |
| — CD log | R6 |

Upgrade Procedures

N/A

Release Data

- **Functionality changes**

N/A

- **New Features**

N/A

Version change

- **Module version changes**

N/A

- **Document Version Changes**

N/A

- **Documentation Deliverable**

N/A

- **Fixed Issues and Bugs**

N/A

References

N/A